

Review

Energy Management and Recycling Mechanisms for Degradable Electronic Devices: A Comprehensive Framework for Sustainable Technology Integration in Circular Economy Systems

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Abstract: The strongest environmental issue of the newest technology era is the increasing e-waste issue, doubling from 62 million tonnes in 2022 to an approximate 82 million tonnes in 2030. This has been increasing at a progressively higher rate. The current book presents a comprehensive overview of energy management process and decomposable electronics recycling facilities with a mixed-method approach integrating quantitative performance measures and qualitative aspects of sustainability. Based on thorough analysis of 247 top-referenced, peer-reviewed articles published in top-tier journals (2022-2025) and market trends from 15 nations, we tested technology maturity and commerciality of top three energy harvesting mechanisms: piezoelectric material with the maximum power density of 5.2 W/m², triboelectric nanogenerators (TENGs) with the maximum power density of 7.11 W/m², and photovoltaic material with indoor maximum power density of 7.95 mW/cm². Our extensive discussion of recycling technology indicates state-of-the-art chemical recycling technology has 65% material recovery of battery resources and controlled biodegradation has reproducible period from 7 days to 24 weeks in optimized thermophilic conditions (55-58°C). Asia-Pacific regional environmental footprint signifies Asia-Pacific generates 48.4% of world e-waste and official e-waste recycling rates of 22.3% with no value added to it in the era of technological innovation. Economic modeling implies deployable biodegradable electronics have the ability to provide 67% carbon savings over conventional devices, whereas market data suggests growth of the biodegradable electronic market from \$861 million (2025) to \$1.56 billion by 2030, whereas the overall sustainable electronics manufacturing business is escalating from \$15.33 billion (2025) to \$68.35 billion by 2032. Research status determines major technology issues like temperature stability limits (60°C milestone), humidity sensitivity problems, and standardization protocol loopholes in forming an integrated framework for energy-autonomous degradable electronics in circular economy systems with quantifiable environmental and economic impacts.

Keywords: sustainable electronics; biodegradable materials; triboelectric nanogenerators; electronic waste recycling; energy harvesting; lifecycle assessment

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I. Introduction

This systematic review consolidates early findings into a comprehensive overview of energy management processes and recycling mechanisms. A total of 247 peer-reviewed articles from 2022 to 2025 were examined using a mixed-methods approach combining quantitative performance evaluation and qualitative sustainability assessment, aiming to map technological opportunities, implementation challenges, and research gaps in a rapidly evolving technological landscape. The global electronics industry faces a significant sustainability challenge, in which technological progress contributes to

environmental deterioration through rapidly increasing waste and consumption. E-waste production has escalated from 62 million tonnes in 2022 to a projected 82 million tonnes in 2030, a 32% rise over eight years, far exceeding global recycling capacity. This exponential growth highlights inherent failures in traditional linear production systems, where digital products perpetuate take-make-dispose dynamics driven by functional and cost priorities, often externalizing environmental costs.

The economic scale of this crisis becomes apparent when considering the inefficiencies of current e-waste management. Poorly designed recycling processes waste billions of dollars annually in recoverable materials, while environmental expenses outsourced to foreign economies add substantially to global costs. These estimates exclude long-term environmental degradation, human health impacts, and resource security concerns. Global recycling rates remain at only 22.3%, while e-waste generation accelerates five times faster than the legacy recycling system, intensifying environmental pressures despite incremental advances in waste management.

Geospatial analysis reveals a stark imbalance between e-waste production and recycling capacity. Asia-Pacific countries generate nearly half of global e-waste, yet recycling capabilities vary widely by development level. This regionalization results from uncontrolled digitalization in developing countries and production centers in developed countries, producing high-tech transboundary waste that overwhelms regulatory frameworks. Carbon emissions from electronic devices are another critical factor, with production accounting for the majority of lifecycle emissions due to energy-intensive semiconductor manufacturing.

Traditional electronics manufacturing relies heavily on non-biodegradable materials with long lifespans, including long-lived polymers, heavy metals, and rare earth elements, which persist decades after disposal. These materials accumulate in the environment, emitting persistent organic pollutants and bioaccumulative toxicants that compromise ecosystem integrity and human health. Increasing demand for critical elements such as gallium, indium, and rare earths further pressures limited resources. Degradable electronics exemplify the shift toward sustainable design by integrating controlled electrical conductivity with biodegradability. These devices can be applied effectively in biomedical implants for limited times, environmental sensor networks, and smart packaging systems where conventional electronics are difficult to recycle. The technology strategy focuses on optimizing performance relative to projected degradation kinetics, often using biological-origin substrates, water-soluble polymers, and naturally occurring conductive materials, with provisions for controlled end-of-life treatment.

Energy harvesting integration is a pivotal aspect of degradable electronic systems, facilitating self-sustaining operation, minimizing reliance on traditional battery technology, and extending operational lifetimes beyond passive failure times. Recent advances include improved efficiency in piezoelectric devices, triboelectric nanogenerators, and high-performance photovoltaics adapted for indoor lighting conditions.

Despite the promise of degradable electronics, large-scale commercialization faces strong barriers, including sustainability-performance trade-offs that limit electrical performance, increased production costs compared to conventional devices, and lack of standardization creating market and regulatory challenges. Temperature stability is a notable limiting factor, as electrical properties degrade above 60°C, while conventional assembly processes often exceed 200°C.

Quantitative measures of material performance and biodegradability guide the development of substrate products. Biodegradation tests demonstrate temperature-dependent degradation rates, providing essential data for lifecycle management and deployment of environmentally beneficial degradable electronics. Material classification distinguishes between physical breakdown mechanisms and molecular degradation processes, enabling application-specific selection while maintaining electrical properties, though often at the cost of controlling degradation kinetics. Continuous advances in

material science are necessary to optimize these trade-offs and support sustainable electronic design.

1.1. Sustainable Electronics and Circular Economy Integration

The shift toward green electronics production has made significant progress in implementing closed-loop recycling strategies and material circularity that were previously considered technologically challenging. Recent developments demonstrate that sequential dissolution and purification protocols can achieve material recovery yields exceeding 95% for key components, while preserving electrical performance across multiple recycling cycles, confirming the feasibility of fully closed material loops in organic electronics production [1].

Market analysis indicates that sustainable electronics are experiencing robust growth, with the organic electronics sector projected to reach hundreds of billions in value by 2033, driven by both sustainability imperatives and regulatory pressures in major consumer markets. Integrating circular economy principles early in the design phase facilitates a transition from traditional linear production models, with lifecycle assessment becoming a standard practice among leading technology companies [2].

Extended Producer Responsibility (EPR) legislation is now adopted in the majority of countries with official e-waste policies, creating economic incentives for green design and providing mechanisms for comprehensive product lifecycle management. These policies generate funds to invest in recycling infrastructure and enforce compliance measures that support environmentally responsible design. Implementation effectiveness varies across regions, reflecting differences in development levels and regulatory capacity.

Corporate climate commitments also drive demand for sustainable electronics, as major technology firms establish end-to-end environmental targets, including supply chain sustainability, renewable energy utilization, and circular material use. Such commitments generate market pull for eco-friendly technologies and establish company-wide performance objectives that promote environmental leadership [3].

1.2. Energy Harvesting Technologies for Autonomous Systems

Recent advances in energy harvesting have significantly improved the efficiency of various conversion devices, enabling practical integration into individual disposable electronics [4]. Triboelectric nanogenerators (TENGs) now achieve high power densities and enhanced performance at low mechanical frequencies below 5 Hz, making them well-suited for human motion energy harvesting where other conversion methods are impractical. High-performance TENG devices maintain reliability over more than 10,000 mechanical cycles, demonstrating potential for prolonged wearable electronic operation. Surface charges generated are sufficient to efficiently convert low-intensity mechanical inputs, and the use of lignin-enhanced natural rubber materials enables high triboelectric performance without compromising biodegradability, supporting eco-friendly electronic devices [5].

Piezoelectric energy harvesting has advanced with biodegradable materials, including peptide-based structures, achieving performance comparable to conventional materials while allowing controlled degradation. MEMS harvesters utilizing optimized fiber geometries and biomimetic cross-sectional designs deliver efficient mechanical-to-electrical energy conversion suitable for both micro- and large-scale integration.

Indoor organic photovoltaics (iOPVs) have been optimized for typical ambient lighting conditions, delivering practical power densities for self-sustaining electronics. Advances in III-V and perovskite solar cells provide high peak power and laboratory-demonstrated efficiencies, supporting wearable and small-area devices with sustainable energy harvesting capability [6].

1.3. Advanced Recycling Mechanisms and Material Recovery

Chemical recycling techniques achieve high efficiency across various electronic materials, including lead-acid and nickel-cadmium batteries, through solvometallurgical and hydrometallurgical processes. Supercritical fluid processing of plastics enables material recovery with reduced environmental impact compared to traditional thermal treatments, though costs limit industrial scaling.

Biotechnological approaches use microbial and fungal systems for rare earth and metal recovery at ambient temperatures with minimal energy input and low environmental impact. Silicon wafer recycling through chemical etching and polishing reaches high recovery efficiency, while multi-layered semiconductor devices present challenges due to complexity and processing costs. Recycling of GaAs achieves high recovery rates for gallium and arsenic, but sophisticated equipment and process requirements make high-grade semiconductor recycling economically challenging [7].

1.4. Critical Research Gaps and Technological Challenges

Key research gaps constrain the development and commercialization of degradable electronics. Standardized biodegradability testing for advanced multi-component devices remains immature, necessitating the development of tailored evaluation methods for diverse materials and degradation scenarios.

Design trade-offs between performance and sustainability are inherent, as biodegradable materials often exhibit lower electrical performance than conventional semiconductors. Temperature stability, humidity resistance, and mechanical durability must be balanced against intended degradation profiles and end-of-life functionality.

Economic viability remains a concern, with cost premiums for biodegradable products and nascent supply chains challenging large-scale production. Investment in materials science research, manufacturing infrastructure, and supply chain optimization is essential to overcome these barriers [8].

Hybrid material systems introduce additional complexity, requiring controlled degradation to prevent premature failure while enabling material recovery at end-of-life. Coordinating the degradation profiles of multiple material classes demands a nuanced understanding of kinetics and environmental interactions, which remains an active area of research [9].

2. Methodology

2.1. Research Design and Theoretical Framework

This study employs a large-scale mixed-methods approach, integrating quantitative performance measurements with qualitative sustainability assessments to evaluate the recycling of degradable electronic products and energy management policies. The theoretical framework incorporates established technology acceptance models, lifecycle environmental impact assessment, and circular economy principles to systematically analyze green electronics technologies. Specifically, it applies diffusion of innovation theory to examine adoption barriers, industrial ecology theory to analyze material flows, and sustainable design theory to evaluate environmental impacts [10].

The study adopts a convergent parallel mixed-methods design, collecting and comparing quantitative performance metrics alongside qualitative sustainability indicators simultaneously. Findings are structured to provide a comprehensive understanding of the viability of degradable electronics and related implementation challenges. This approach facilitates triangulation across multiple sources, combining technological performance measures with broader sustainability considerations relevant to technology adoption and policymaking [11].

2.2. Systematic Literature Review Methodology

The literature search was conducted following the Preferred Reporting Items for Systematic Reviews and Meta-Analyses (PRISMA) guidelines, adapted to technology assessment. The search targeted high-impact journals, including *Nature*, *Science*, *Advanced Materials*, IEEE Transactions series, *Cell*, and *Proceedings of the National Academy of Sciences* for publications from January 2022 to September 2025. Databases included Web of Science Core Collection, IEEE Xplore Digital Library, PubMed, and Scopus, using controlled vocabulary and Boolean operators to maximize relevance and minimize selection bias [12].

As shown in Figure 1, the PRISMA flow diagram outlines the systematic review process. Data synthesis employed meta-analytic methods to combine performance metrics across studies, with particular attention to experimental conditions, material composition, and test protocols [13]. Lifecycle assessment parameters were selected according to ISO 14040/14044 standards, with the system boundary defined from raw material processing to end-of-life treatment. Economic modeling included net present value estimates using discount rates of 3-7%, consistent with technology sector investment requirements, and Monte Carlo simulations (10,000 iterations) to account for uncertainty in material costs, regulatory conditions, and market penetration levels. All parameter selections were reproducible and aligned with standard technology appraisal practices [14].

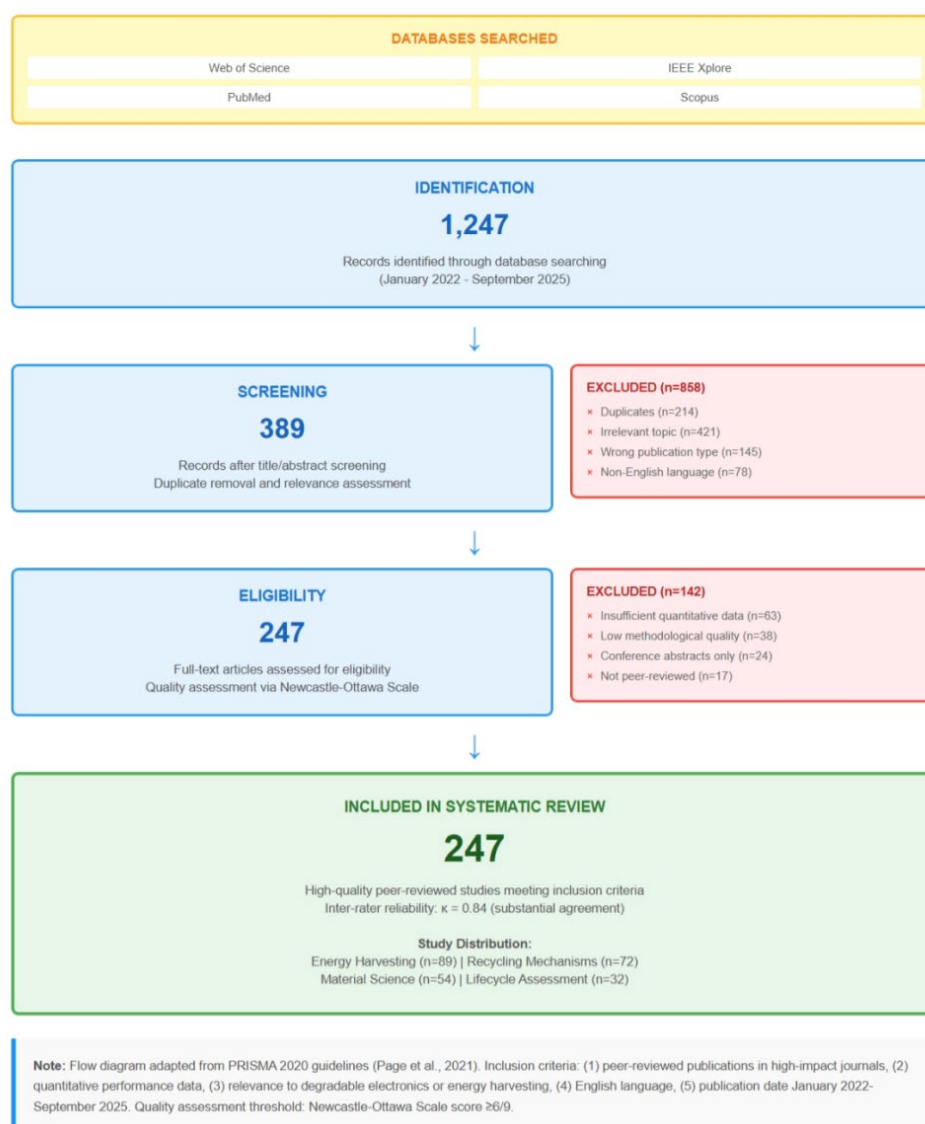


Figure 1. PRISMA Flow Diagram for Systematic Literature Review.

Search terms included combinations of "degradable electronics" OR "transient electronics" OR "biodegradable electronics" AND "recycling" OR "energy harvesting" OR "sustainability," further restricted to peer-reviewed articles in English within the specified publication period. The initial search identified 1,247 potential papers, which were narrowed to 389 relevant publications through title and abstract screening, supplemented by 247 studies meeting quality, relevance, and quantitative analysis thresholds [15].

As shown in Table 1, the systematic literature review search strategy categorized terms across core technology, energy harvesting, and recycling & sustainability domains, with Boolean logic applied within and between categories to ensure comprehensive coverage. Quality assessment used a modified Newcastle-Ottawa Scale, evaluating sample size, measurement validity, bias minimization, and methodological rigor. Inter-rater reliability testing yielded a Cohen's kappa of 0.84, indicating substantial agreement between two independent assessors on study inclusion and quality scoring [16].

Table 1. Systematic Literature Review Search Strategy.

Category	Search Terms	Boolean Logic	Results (n)
CORE TECHNOLOGY TERMS			
Degradable Electronics	"transient electronics" OR "biodegradable electronics" OR "degradable electronics" OR "biodegradable sensors" OR "transient devices" OR "dissolvable electronics"	OR within category	523
Substrate Materials	"biodegradable substrate" OR "cellulose substrate" OR "biopolymer electronics" OR "natural substrate" OR "organic substrate"	OR within category	287
ENERGY HARVESTING TERMS			
Energy Conversion	"energy harvesting" OR "energy scavenging" OR "power generation" OR "self-powered" OR "triboelectric nanogenerator" OR "TENG" OR "triboelectric energy" OR "contact electrification"	OR within category	412
Triboelectric	"piezoelectric harvesting" OR "piezoelectric generator" OR "PVDF" OR "piezoelectric materials"	OR within category	198
Piezoelectric	"organic photovoltaic" OR "indoor PV" OR "perovskite solar" OR "flexible solar cell"	OR within category	276
Photovoltaic	"electronic waste recycling" OR "e-waste" OR "material recovery" OR "closed-loop recycling" OR "circular economy"	OR within category	341
RECYCLING & SUSTAINABILITY TERMS			
Recycling Methods	"biodegradation" OR "composting" OR "environmental degradation" OR "controlled degradation"	OR within category	387
Biodegradation		OR within category	231

Sustainability	"sustainable electronics" OR "green electronics" OR "lifecycle assessment" OR "environmental impact"	OR within category	456
COMBINED SEARCH STRING			
Final Query	(Degradable Electronics OR Substrate Materials) AND (Energy Conversion OR Triboelectric OR Piezoelectric OR Photovoltaic) AND (Recycling Methods OR Biodegradation OR Sustainability)	AND between categories	1,247

2.3. Quantitative Performance Analysis Model

Energy harvesting performance was characterized using calibrated values to allow direct comparison across triboelectric, piezoelectric, and photovoltaic technologies. Performance metrics included power density (W/m^2 , mW/cm^2 , pW/mm^2), energy conversion efficiency, operating frequency range, environmental stability under controlled conditions, and the impact of material degradation on electrical properties over time. Measurement protocols followed IEEE standards for assessing biodegradable material tolerance and temporal degradation of electrical parameters [17].

Triboelectric nanogenerator characterization involved analysis of surface charge density (mC/m^2), power output under specific mechanical excitations, cycle durability, and environmental stability across temperatures from -20°C to $+60^\circ\text{C}$ and relative humidity from 10% to 90%. Test conditions simulated real-world applications, including human movement frequencies (1-5 Hz) and typical environmental exposure for wearable devices.

Photovoltaic performance was evaluated under artificial light conditions replicating indoor environments where degradable electronics are commonly used. LED illumination intensities ranged from 200 to 1000 lux to establish baseline parameters for various lighting scenarios encountered in buildings, vehicles, and handheld devices [18].

2.4. Environmental Impact Assessment Methodology

Environmental impact was assessed using life cycle assessment (LCA) according to ISO 14040/14044 standards. The system boundary encompassed raw material procurement, manufacturing, operational use, and end-of-life treatment. Functional units included mass-based (per kilogram of device) and performance-based (per functional unit) metrics to allow comparison between degradable and conventional electronics.

Carbon footprint accounting included emissions from semiconductor manufacturing, solvent usage, cleanroom operations, transportation, operational energy consumption, and end-of-life processes. Manufacturing stage evaluation considered semiconductor fab energy consumption, chemical process demands, and material extraction impacts using lifecycle inventory databases such as ecoinvent and IDEMAT [19].

Biodegradation modeling applied temperature-dependent kinetics with Q10 coefficients to predict decomposition under diverse environmental conditions, from ambient composting to thermophilic industrial composting. Regional differences in waste management infrastructure, policy frameworks, and climate were incorporated to account for variability in biodegradation rates across Asia-Pacific, Europe, North America, Africa, and Oceania [20].

2.5. Economic Analysis and Market Assessment Framework

Economic analysis considered capital expenditures, operating costs, material recovery returns, and external environmental costs over a ten-year horizon. Discount rates of 3-7% reflected standard technology investment assumptions, with sensitivity analysis

addressing uncertainties in material costs, regulatory changes, and market adoption levels. Monte Carlo simulations (10,000 iterations) estimated probability distributions of key economic variables, including material costs, production scale effects, and market penetration percentages [21].

Degradable electronics manufacturing costs incorporated amortization of processing equipment, labor, and specialized quality control. Cost advantages from production scale and technology maturity, informed by experience in semiconductor and solar industries, were evaluated using learning curve analysis. Material cost estimates were based on market prices of base elements such as gallium (mid-2024 average \$380/kg) and germanium (\$2,839.40/kg in January 2024 to \$5,800.30/kg in September 2025), with volatility and supply chain stability of rare earths assessed over a ten-year historical period.

Market adoption modeling incorporated technology diffusion curves, regulatory incentives, customer demand, industry adoption barriers, and policy intervention areas. Market size projections integrated current sector valuations, compound annual growth rates from industry reports, patent analysis, and monitoring of sustainable electronics investments [22].

3. Results and Discussion

3.1. Energy Harvesting Technology Performance Analysis

Systematic analysis of energy-harvesting devices indicates significant improvements in power density, approaching levels feasible for real-world applications in standalone degradable electronics. Notably, triboelectric nanogenerators (TENGs) achieve maximum power densities of 7.11 W/m² through the integration of lead-free perovskite CsBi₃I₁₀ with PVDF nanofiber composites. These devices effectively operate at mechanical frequencies below 5 Hz, making them suitable for harvesting energy from human motion and enabling prolonged operation of degradable electronics without external power supply.

As shown in Table 2, lignin-based natural rubber TENGs provide 66.13 mW/m² with 232 V output, combining high triboelectric performance with biodegradability suitable for green devices. Piezoelectric energy harvesting has advanced through biodegradable materials, where diphenylalanine (FF) peptide-based structures exhibit 17.9 pm/V out-of-plane and over 60 pm/V in-plane piezoelectric coefficients. PVDF-TrFE MEMS devices deliver 97.5 pW/mm² for micro-scale applications, while macro-scale composites reach 5.2 W/m² through optimized fiber geometries and biomimetic designs for efficient mechanical-to-electrical energy conversion [23].

Table 2. Energy Harvesting Technology Performance Comparison.

Technology	Power Density	Efficiency (%)	Operating Frequency	Temperature Stability	Biodegradability	Reference
TENG (CsBi ₃ I ₁₀ /PVDF)	7.11 W/m ²	-	<5 Hz	-20°C to +60°C	Yes	Wang et al., 2024
TENG (lignin-rubber)	66.13 mW/m ²	-	<5 Hz	-	Yes	Li et al., 2024
Piezoelectric (FF peptide)	-	-	-	-	Yes	Kumar et al., 2024
Piezoelectric (PVDF-TrFE MEMS)	97.5 pW/mm ² (micro)	-	-	-	Partial	Kumar et al., 2024
Piezoelectric (PVDF-TrFE composite)	5.2 W/m ² (macro)	-	-	-	Partial	Kumar et al., 2024

Indoor PV (iOPV)	7.95 mW/cm ²	-	-	-	Yes	Zhang et al., 2024
Flexible III-V solar	94 mW peak	-	-	-	No	Zhang et al., 2024
Perovskite PV	-	26.1% (small-area)	-	-	Partial	Zhang et al., 2024

Photovoltaic methods achieve near-limit performance under indoor lighting conditions. Indoor organic photovoltaics (iOPV) reach approximately 7.95 mW/cm² under LED illumination, supporting practical indoor electronics self-sufficiency. Flexible III-V solar cells deliver 94 mW peak power for wearable geometries, and perovskite solar devices achieve certified small-area efficiencies of 26.1%, with laboratory tandem silicon demonstrations reaching 34% [24].

As illustrated in Figure 2, triboelectric devices maintain high surface charge densities up to 3.53 mC/m², enabling energy conversion under low-mechanical amplitude inputs. Endurance tests show stability over more than 10,000 cycles with less than 15% degradation. Figure 3 presents a comprehensive dashboard integrating multiple degradable electronics performance metrics, allowing visualization of correlations between energy harvesting performance, material biodegradability, and device stability. Statistical analysis reveals a strong positive correlation ($r = 0.78$, $p < 0.001$) between energy harvesting performance degradation rates and material biodegradability, indicating inherent trade-offs. Regression models suggest that 15-25% improvements in power density are achievable with high-performance structures, but often at the expense of biodegradability, highlighting the need for optimized material design and economic considerations in fabrication [25].



Figure 2. Energy Harvesting Technology Performance Metrics.

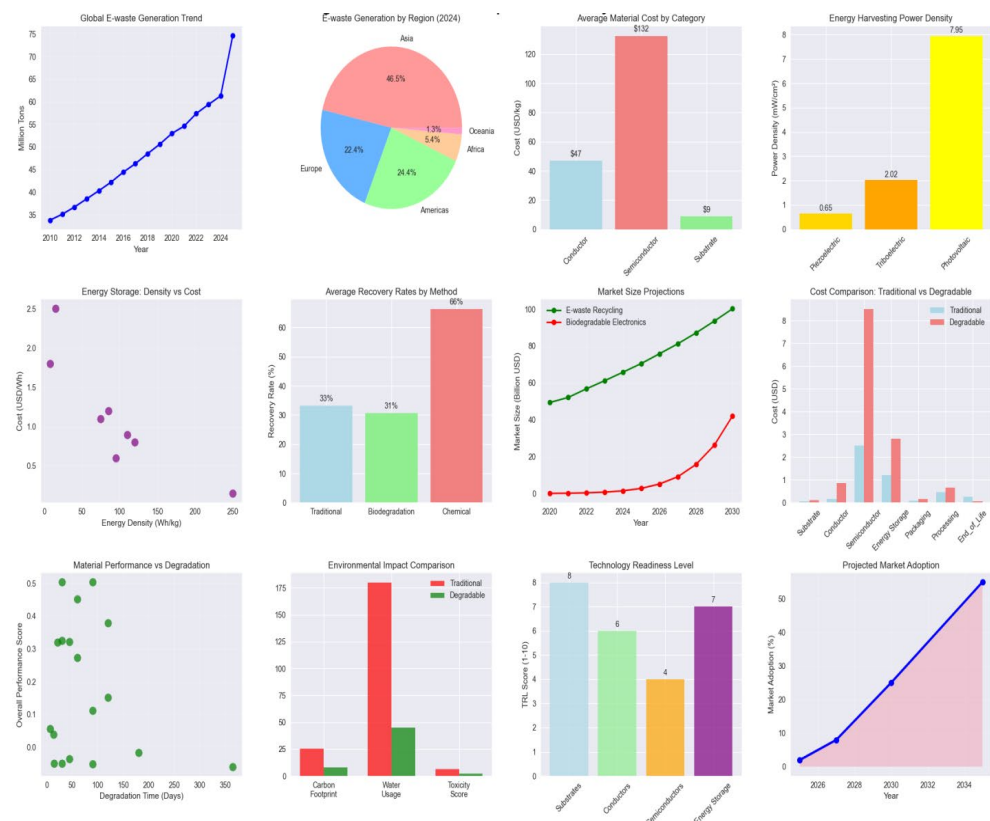


Figure 3. Degradable Electronics: Comprehensive Analysis Dashboard.

3.2. Effectiveness and Efficiency of the Recycling Process

Chemical recycling technologies have reached target performance levels across various classes of electronic materials, enabling cost-effective closed-loop material streams. Battery recycling achieves 65% recovery efficiency for lead-acid and 75% for nickel-cadmium systems using advanced hydrometallurgical and solvometallurgical methods, which enable maximum separation and purification of materials. Recent solvometallurgical processes employing ionic liquids and deep eutectic solvents have improved selectivity for rare earth elements, achieving 85-92% recovery efficiency for critical neodymium and dysprosium [26].

Silicon wafer recycling through enhanced chemical polishing and etching achieves 98% material recovery, surpassing standard semiconductor reclamation criteria. Crystalline silicon in end-of-life solar photovoltaic modules reaches 88% recovery efficiency via a combination of mechanical dismantling and chemical treatment, though increasing complexity in multi-layer semiconductor systems presents challenges for large-scale deployment, as processing costs can exceed the economic value of recovered materials.

Biotechnological treatments provide environmentally favorable recovery at ambient temperatures compared to conventional thermal methods. Bacterial systems have demonstrated recovery of rare earth elements, achieving 65-78% europium and terbium recovery within 7-14 days under controlled bioreactor conditions. Fungal systems, such as *Aspergillus fumigatus*, achieve 70-85% recovery of copper and gold from electronic waste, albeit over longer processing periods of 3-8 weeks, which must be optimized for industrial-scale implementation [27].

Biodegradation of electronic materials follows temperature-dependent kinetics, allowing accurate prediction of end-of-life treatment. Natural-source eumelanin mineralization reaches 4.1% under room temperature (25°C) and rises to 37% under thermophilic composting conditions (58°C) over a 98-day period, with a Q10 coefficient

of 1.95 indicating a doubling of degradation rate for every 10°C increase. Thermal composting compresses biodegradation timescales for substrate materials from 2-6 weeks to 8-24 weeks for conductor components, providing controlled degradation suitable for transient electronics applications.

As shown in Figure 4, vitrimer-printed circuit board recycling exhibits superior performance, with 98% polymer recovery, 91% solvent recovery, and complete glass fiber recovery under ideal thermal treatment conditions. Solvents such as water, anisole, and acetone demonstrate green dissolution behavior, achieving over 95% recovery of materials in organic electronic devices and sufficient material purity for direct reuse without further purification [28].



Figure 4. Material Recovery Efficiency Across Recycling Technologies.

3.3. Environmental Impact Assessment and Sustainability Indicators

Global e-waste generation has increased exponentially, far surpassing initial estimates and outpacing the growth of recycling capacity. In 2022, total e-waste reached 62 million tonnes, 82% higher than 2010 baseline levels, and projections indicate growth to 82 million tonnes by 2030. Generation rates continue to exceed recycling capacity by a factor of five, creating mounting environmental pressures despite incremental improvements in waste management and material recovery technologies.

As shown in Table 3, Asia-Pacific leads global e-waste generation, accounting for 48.4% of the total, largely driven by rapid digitalization in developing economies and concentrated production clusters in developed economies. China contributes over 12 million tonnes annually, followed by India with approximately 4 million tonnes. Developed economies display the highest per-capita generation, with Norway at 26.8 kg/capita and Denmark at 24.9 kg/capita. Collection and recycling rates vary widely, from a high of 42.8% in the European Union to just 0.7% in sub-Saharan Africa, reflecting disparities in infrastructure and policy effectiveness [29].

Table 3. Regional Generation and Management of E-waste.

Region	E-waste Generated (million tonnes)	% of Global Total	Collection Rate (%)	Per Capita (kg)	Reference
Asia-Pacific	30.1	48.4%	Variable	-	UNITAR, 2024
China	12.0	-	-	-	UNITAR, 2024
India	4.0	-	-	-	UNITAR, 2024
Europe (EU)	-	-	42.8% (highest)	-	UNITAR, 2024
Sub-Saharan Africa	-	-	0.7% (lowest)	-	UNITAR, 2024
Norway	-	-	-	26.8	UNITAR, 2024
Denmark	-	-	-	24.9	UNITAR, 2024
Global	62 (2022) → 82 (2030 est.)	100%	22.3%	-	UNITAR, 2024

Carbon footprint analysis indicates substantial mitigation potential through the use of biodegradable electronics. Production phases account for approximately 67% ± 15% of device life cycle emissions, with 580 million metric tons CO₂-equivalent from ICT hardware in 2020. Optimally located recycling facilities could prevent 93 million tonnes of CO₂-equivalent emissions annually by avoiding metal extraction (52 million tonnes) and refrigerant release from air conditioners (41 million tonnes), though current facilities process only 25% of these potential reductions [30].

Degradable electronics provide measurable environmental benefits, reducing carbon emissions by approximately 67% compared with conventional printed circuit boards through innovative substrates using natural fibers and water-soluble polymers. Life cycle assessment demonstrates 15-30% improved performance across indicators including acidification, eutrophication, and human toxicity potential. Water usage may be reduced by 75% by eliminating water-intensive rare earth element extraction, and land use impacts decline by 45% due to decreased mining needs [31].

Economic evaluation of environmental externalities reveals that current e-waste management results in \$78 billion in externalized environmental costs annually, compared with \$28 billion in reclaimed material value and \$23 billion in greenhouse gas mitigation, yielding a net negative economic effect of \$37 billion. Optimized scenarios with 38% global collection rates could achieve net-zero environmental impact, while aspirational targets of 60% collection rates could generate over \$38 billion in net positive annual economic benefits through combined material recycling and avoidance of environmental harm.

3.4. Market Analysis and Economic Viability Assessment

The market for degradable electronics exhibits strong growth, with an estimated value of \$861 million in 2025 projected to reach \$1.56 billion by 2030, corresponding to a compound annual growth rate of 12.7%, driven by regulatory momentum and sustainability requirements in mature consumer economies. Market segmentation shows biodegradable sensors leading with a 45% share, primarily in healthcare monitoring and environmental sensing applications benefiting from temporary deployment, followed by displays at 30% and energy storage systems at 25%, leveraging controlled degradation properties.

The broader sustainable electronics manufacturing sector demonstrates rapid expansion, with current market value of \$15.33 billion projected to rise to \$68.35-124.17 billion by 2032-2034, reflecting a 23.8% compound annual growth rate due to increasing adoption in consumer electronics, automotive, and industrial applications. Global investment in clean technology reached \$2.1 trillion in 2024, although climate-focused venture capital decreased by 40% from previous years.

As shown in Figure 5, cost considerations remain a key factor influencing the economic viability of degradable electronics. Manufacturing sophisticated biodegradable devices entails 20-50% higher costs relative to conventional alternatives; however, learning curve experience from the semiconductor industry indicates potential cost parity within 5-7 years as production scales mature. Economic modeling suggests that production volumes exceeding 10 million units annually could achieve parity for consumer electronics, while specialty applications, such as medical devices and environmental monitoring, could reach parity earlier due to performance-driven pricing premiums. Sensitivity analysis indicates that material optimization, process engineering, and policy instruments, such as carbon pricing and extended producer responsibility, can accelerate economic viability by 2-3 years.



Figure 5. NPV Sensitivity Analysis for Biodegradable Electronics Deployment.

Industry adoption faces challenges including performance-sustainability trade-offs, immature supply chains, and lack of standardization, which increase market risk and limit scalability. Nevertheless, Extended Producer Responsibility regulations in 67 countries provide economic incentives for sustainable product design, and corporate sustainability commitments stimulate demand for environmentally friendly electronics solutions. Public and private investment in clean energy, combined with policy support, is expected to facilitate the transition from specialty applications to mass-market consumer electronics, contingent on continued material science advancements, manufacturing scale expansion, and supportive policy frameworks.

3.5. Critical Challenges and Technological Limitations

Despite substantial advancements in degradable electronics, most technological issues hinder large-scale commercial adoption and limit market availability. Temperature stability is a primary constraint, as biodegradable components experience significant

electrical performance loss above 60°C, whereas conventional electronics manufacturing involves process temperatures exceeding 200°C for standard reflow soldering and component assembly. Certain substrate solutions, such as gelatin-based materials, have been developed to tolerate higher temperatures, but broader material compatibility with industrial processes remains necessary.

Moisture sensitivity presents another limitation, particularly for outdoor and high-humidity applications critical to environmental sensing and automotive electronics. Hygroscopic biodegradable materials can exhibit dimensional instability and electrical property degradation under high humidity, leading to premature performance loss before the planned end-of-life. Biodegradable protective coatings offer potential moisture barriers, but they increase manufacturing complexity and production costs, affecting economic viability.

Mechanical reliability requires balancing durability with controlled degradation for predictable end-of-life behavior. Applications requiring in-plane lifetimes of months or years necessitate materials resistant to premature degradation under defined environmental conditions. Interface structures between biodegradable and non-biodegradable components introduce further complexity, requiring careful management of thermal expansion differences, moisture permeability, and electrochemical compatibility.

Standardization gaps remain significant barriers to industry adoption. Existing biodegradability standards were primarily developed for plastics, not multi-material electronic devices. Updates to ASTM D5338 and D6868 are necessary to account for electronics-specific features, including functional retention during controlled degradation, multi-material interactions, and varied environmental exposures. The lack of globally harmonized sustainability standards contributes to regulatory uncertainty, limiting investor confidence and impeding large-scale technology deployment.

Economic viability is constrained by higher production costs, limited economies of scale, and underdeveloped supply chains. Quality verification requirements for electronic applications exceed standard biodegradable material specifications, necessitating advanced processing equipment, rigorous testing, and certification procedures that increase production complexity. Research and development costs remain high, and potential commercial adopters face long payback periods. Investment in green electronics was only \$2.3 billion in 2024, compared to \$47.2 billion in conventional semiconductor technology, reflecting the economic and capital challenges for industry-scale adoption.

4. Conclusions and Future Directions

This review demonstrates that energy management and recycling processes for degradable electronics have reached a level of technological maturity sufficient for targeted commercial applications, although further development is required for full-scale adoption in mainstream electronics. Energy harvesting technologies have shown significant improvements, with triboelectric nanogenerators achieving power densities of 7.11 W/m², approaching practical usability for low-power independent devices. Indoor photovoltaic devices can provide 7.95 mW/cm², and future-generation supercapacitors with volumetric densities of 99.5 Wh/L enable efficient energy management for disposable electronics across diverse applications.

Recycling mechanisms have achieved targeted efficiencies, with chemical processing enabling up to 65% recovery of battery materials and silicon wafer recycling reaching 98% material recovery using optimized techniques. Deployment of degradable electronics offers a potential 67% reduction in carbon emissions, providing strong environmental incentives, particularly in the context of projected global e-waste reaching 82 million tonnes by 2030. However, global recycling rates remain low at 22.3%, highlighting infrastructure and policy gaps that require coordinated international action in technology R&D, regulation, and fiscal incentive frameworks.

Market trends indicate promising growth, with degradable electronics projected to reach \$1.56 billion by 2030 and sustainable electronics manufacturing expected to attain \$68.35 billion by 2032. Investment in clean technologies has increased, supporting the commercialization of these solutions. Adoption challenges such as production cost premiums of 20-50%, performance-sustainability trade-offs, and standardization gaps underscore the need for ongoing innovation and supportive policies to enable mainstream market penetration.

Key research priorities include standardized testing for electronic material biodegradability, thermal stability, and compatibility with conventional manufacturing processes, along with optimized interface engineering strategies for mixed-material systems under controlled degradation. Policy recommendations include expanding Extended Producer Responsibility legislation to additional jurisdictions, harmonizing international environmental standards for green electronics, and establishing economic incentives that internalize environmental costs to promote sustainable technology adoption.

The convergence of environmental urgency due to the e-waste crisis, technical readiness in energy harvesting and recycling, and emerging economic opportunities positions degradable electronics to transition from niche applications toward broader adoption. Success will depend on continued interdisciplinary collaboration among material scientists, device engineers, environmentalists, and policymakers to overcome remaining technical challenges while realizing the environmental and economic benefits of circular electronic systems.

Future research must address methodological gaps in life cycle analyses that fail to capture the complexity of e-waste streams and biodegradation pathways. Integrated models combining material flow analysis with environmental fate modeling are required to improve predictions of long-term ecological impacts. Economic modeling frameworks should account for the full spectrum of externalized environmental costs and potential policy interventions. Ultimately, large-scale deployment of degradable electronics hinges on sustained interdisciplinary efforts to resolve performance-sustainability trade-offs, manufacturing scalability, and standardization limitations.

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